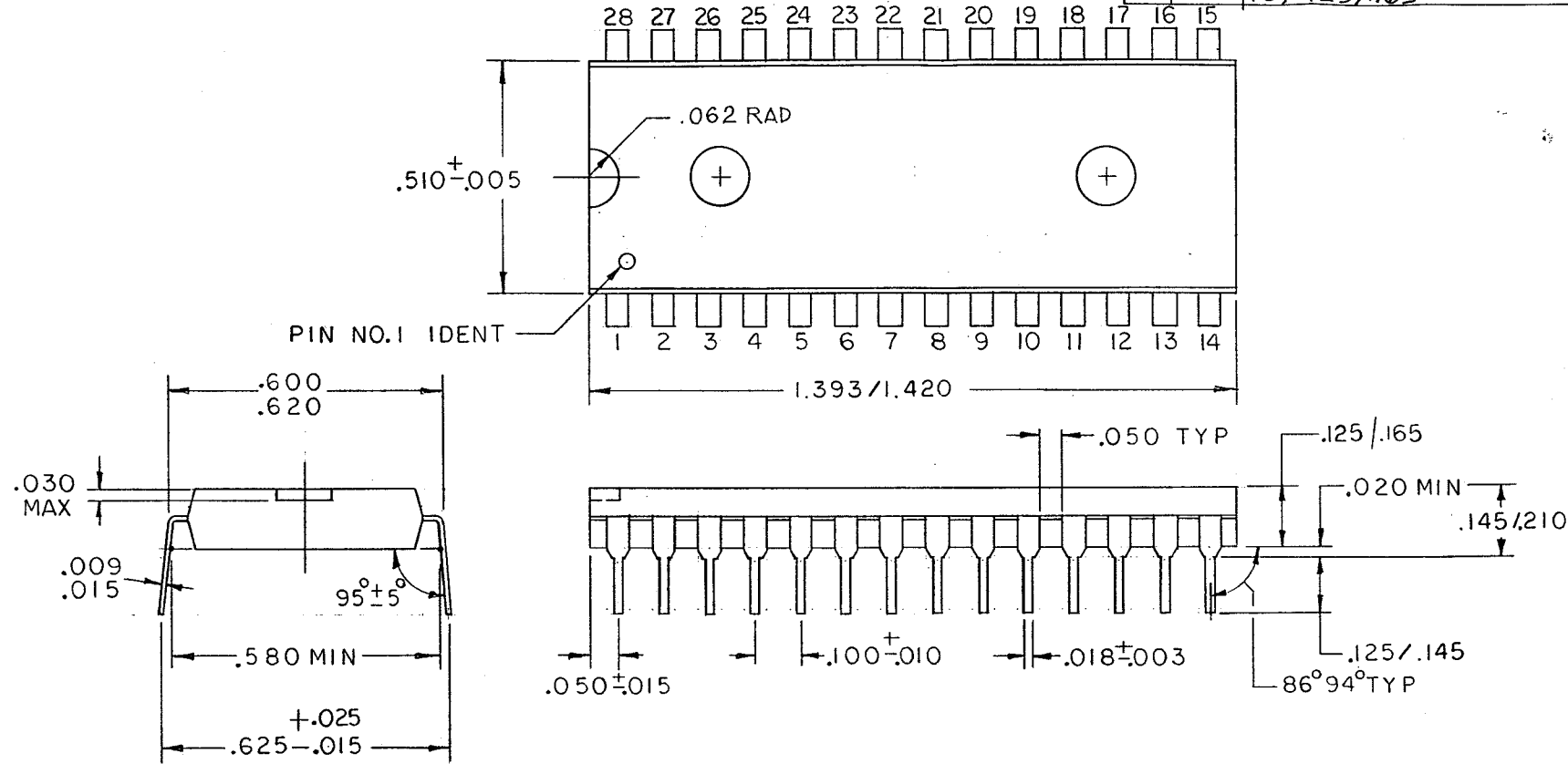


				REVISIONS			
D	I	ADDED EJECTOR PINS	00107	7.19.83	7.19.83		
E	I	CHANGED 1.420 MAX TO 1.393/1.420 .125 MIN TO .125/.145 ADDED .145/.210 DIM. REMOVED .060 DIM.	00846	11-22-83	11-22-83		
REV.	SHEET	DESCRIPTION	E.C.O.	DATE	APPROVED		
A	I	NEW DW'G	D3728	2-13-79	Boyer		
B	I	ADDED 95° ± 5° AND 86°/94° TYP	D3792	3-23-79	Boyer		
C	I	CHANGED DIM. WAS .130 ± .005 TO .125/.165	D7526	10/8/82	Tippelma		



STANDARD LEAD FINISH:
200 μ INCH MINIMUM LEAD/TIN 37/63
ON ALLOY 42 OR EQUIVALENT
OR COPPER

COMPANY PRIVATE				 National Semiconductor Corporation 2900 Semiconductor Drive, Santa Clara, Calif. 95051	
DRAWN: J. MACIEL	DATE: 2-13-79	APPROVED:	DATE:	28 LEAD MOLDED DIP (N)	
CHECKED: K/P	DATE: 2/28/79	APPROVED:	DATE:	B MKT-N28B	
ENGINEER: K/P	DATE: 2/28/79	RELEASED:	DATE:	SHEET OF	REV. E